Complementary Plastic Power Transistors

NPN/PNP Silicon DPAK For Surface Mount Applications

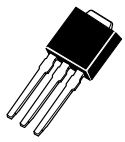
NPN
MJD200
PNP
MJD210

SILICON
POWER TRANSISTORS
5 AMPERES
25 VOLTS
12.5 WATTS

. . . designed for low voltage, low–power, high–gain audio amplifier applications.

- Collector–Emitter Sustaining Voltage —
  $V_{CEO(sus)}$ = 25 Vdc (Min) @ I_C = 10 mAdc
- High DC Current Gain —
  h_{FE} = 70 (Min) @ I_C = 500 mAdc
  = 45 (Min) @ I_C = 2 Adc
  = 10 (Min) @ I_C = 5 Adc
- Lead Formed for Surface Mount Applications in Plastic Sleeves (No Suffix)
- Straight Lead Version in Plastic Sleeves (“–1” Suffix)
- Lead Formed Version in 16 mm Tape and Reel (“T4” Suffix)
- Low Collector–Emitter Saturation Voltage —
  $V_{CE(sat)}$ = 0.3 Vdc (Max) @ I_C = 500 mAdc
  = 0.75 Vdc (Max) @ I_C = 2.0 Adc
- High Current–Gain — Bandwidth Product —
  f_T = 65 MHz (Min) @ I_C = 100 mAdc
- Annular Construction for Low Leakage —
  I_{CBO} = 100 nAdc @ Rated V_{CB}

CASE 369A–13

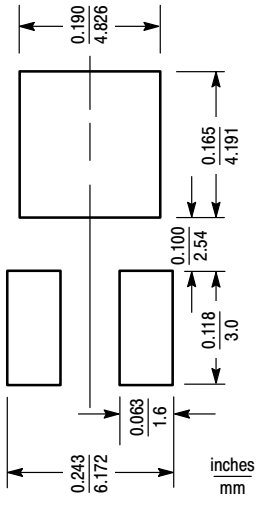


CASE 369–07

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector–Base Voltage	V_{CB}	40	Vdc
Collector–Emitter Voltage	V_{CEO}	25	Vdc
Emitter–Base Voltage	V_{EB}	8	Vdc
Collector Current — Continuous Peak	I_C	5 10	Adc
Base Current	I_B	1	Adc
Total Device Dissipation @ T_C = 25°C Derate above 25°C	P_D	12.5 0.1	Watts W/°C
Total Device Dissipation @ T_A = 25°C* Derate above 25°C	P_D	1.4 0.011	Watts W/°C
Operating and Storage Junction Temperature Range	T_J, T_{stg}	–65 to +150	°C

MINIMUM PAD SIZES RECOMMENDED FOR SURFACE MOUNTED APPLICATIONS



THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case Junction to Ambient*	$R_{\theta JC}$ $R_{\theta JA}$	10 89.3	°C/W

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit
OFF CHARACTERISTICS				
Collector–Emitter Sustaining Voltage (1) (I_C = 10 mAdc, I_B = 0)	$V_{CEO(sus)}$	25	—	Vdc
Collector Cutoff Current (V_{CB} = 40 Vdc, I_E = 0) (V_{CB} = 40 Vdc, I_E = 0, T_J = 125°C)	I_{CBO}	 — —	 100 100	nAdc
Emitter Cutoff Current (V_{BE} = 8 Vdc, I_C = 0)	I_{EBO}	—	100	nAdc
ON CHARACTERISTICS				
DC Current Gain (2) (I_C = 500 mAdc, V_{CE} = 1 Vdc) (I_C = 2 Adc, V_{CE} = 1 Vdc) (I_C = 5 Adc, V_{CE} = 2 Vdc)	h_{FE}	 70 45 10	 — 180 —	—
Collector–Emitter Saturation Voltage (2) (I_C = 500 mAdc, I_B = 50 mAdc) (I_C = 2 Adc, I_B = 200 mAdc) (I_C = 5 Adc, I_B = 1 Adc)	$V_{CE(sat)}$	 — — —	 0.3 0.75 1.8	Vdc
Base–Emitter Saturation Voltage (1) (I_C = 5 Adc, I_B = 1 Adc)	$V_{BE(sat)}$	—	2.5	Vdc
Base–Emitter On Voltage (1) (I_C = 2 Adc, V_{CE} = 1 Vdc)	$V_{BE(on)}$	—	1.6	Vdc
DYNAMIC CHARACTERISTICS				
Current–Gain — Bandwidth Product (3) (I_C = 100 mAdc, V_{CE} = 10 Vdc, f_{test} = 10 MHz)	f_T	65	—	MHz
Output Capacitance (V_{CB} = 10 Vdc, I_E = 0, f = 0.1 MHz)	MJD200 MJD210	C_{ob}	— —	80 120	pF

*When surface mounted on minimum pad sizes recommended.

(continued)

(1) Pulse Test: Pulse Width = 300 μs, Duty Cycle ≈ 2%.

(2) Pulse Test: Pulse Width = 300 μs, Duty Cycle ≈ 2%.

(3) $f_T = |h_{fe}| \bullet f_{test}$.

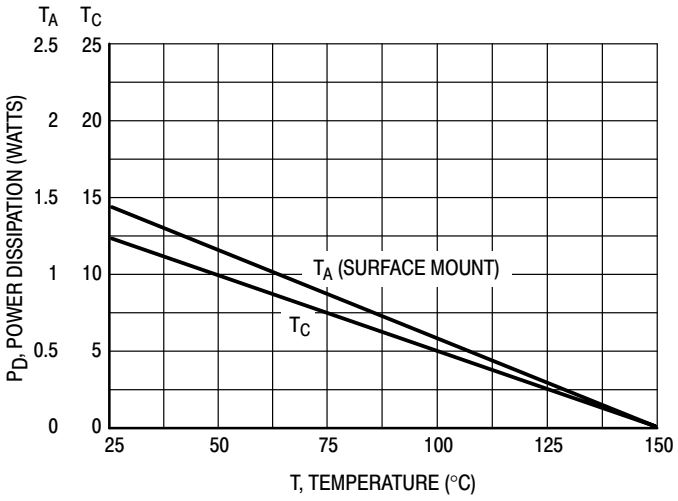


Figure 1. Power Derating

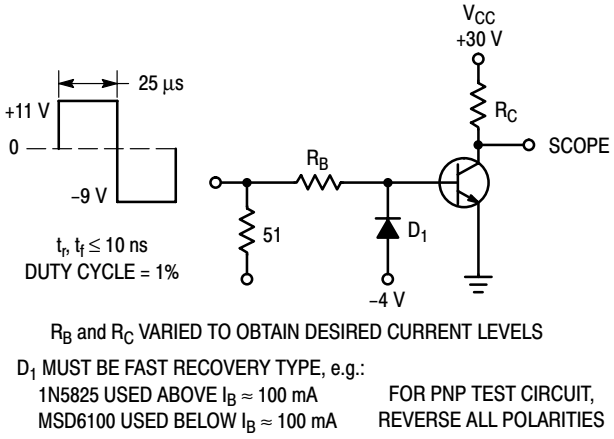


Figure 2. Switching Time Test Circuit

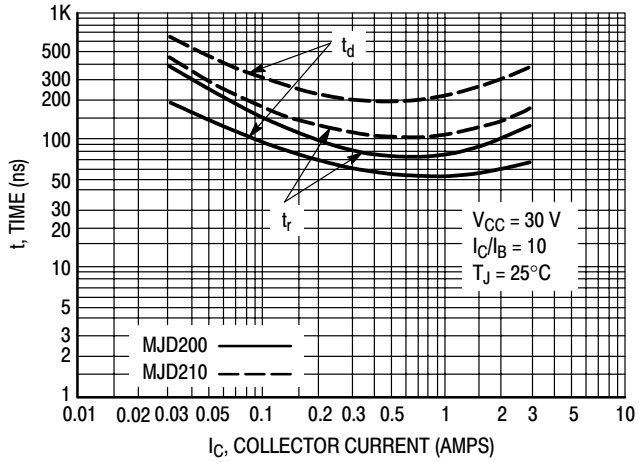


Figure 3. Turn−On Time

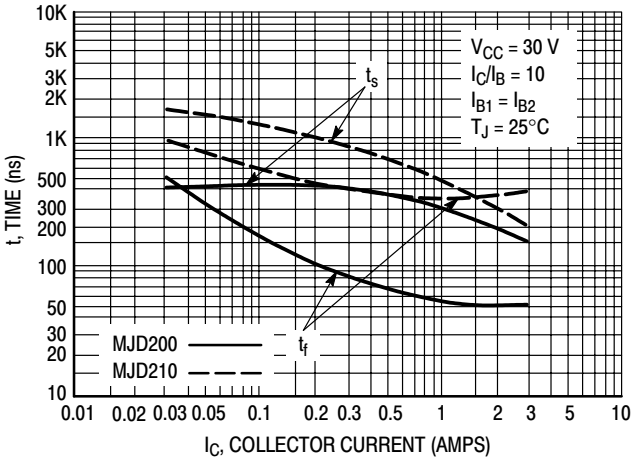
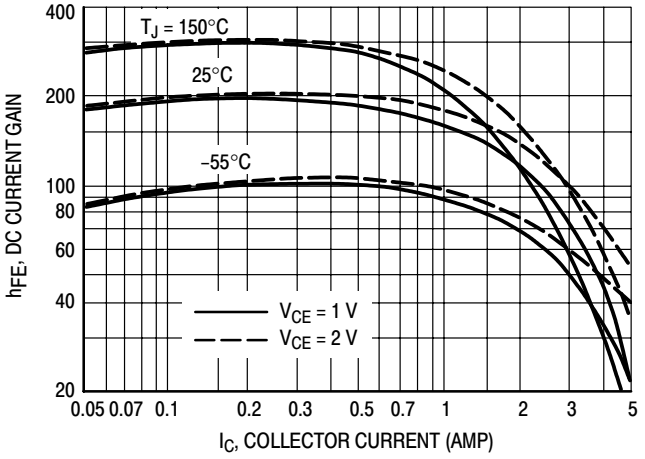


Figure 4. Turn−Off Time

NPN
MJD200



PNP
MJD210

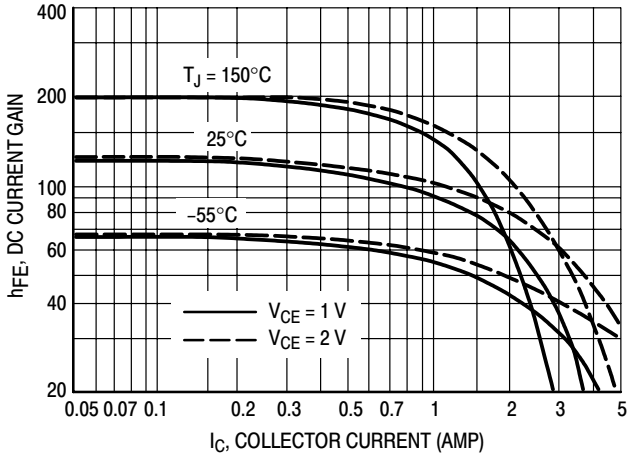
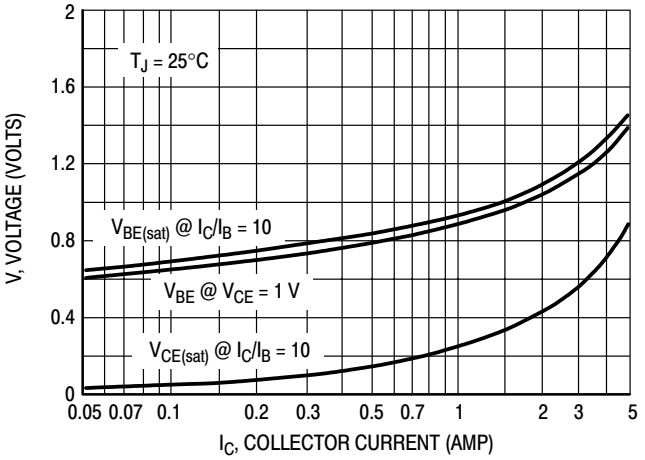


Figure 5. DC Current Gain



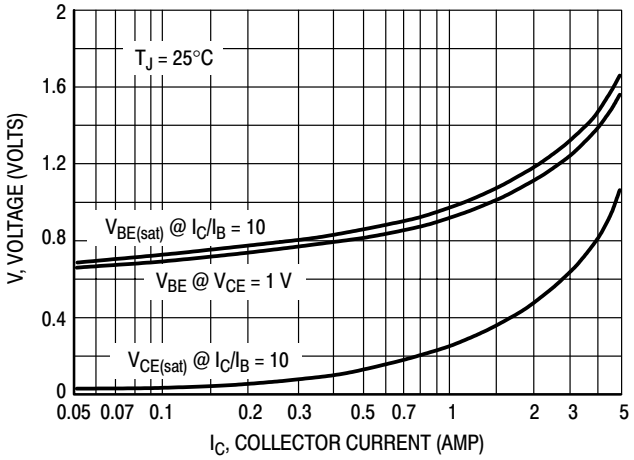
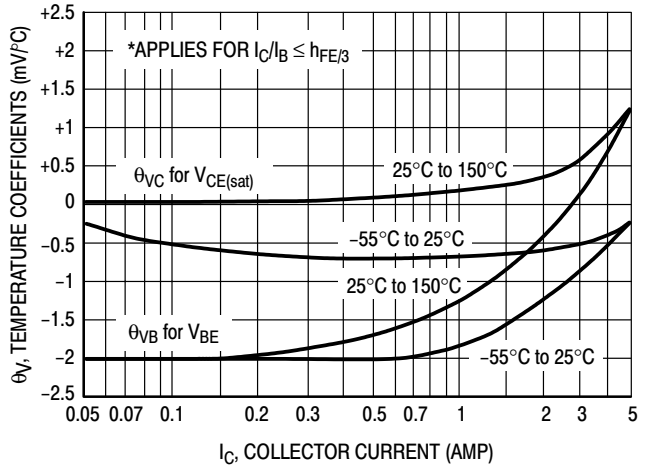


Figure 6. “On” Voltage



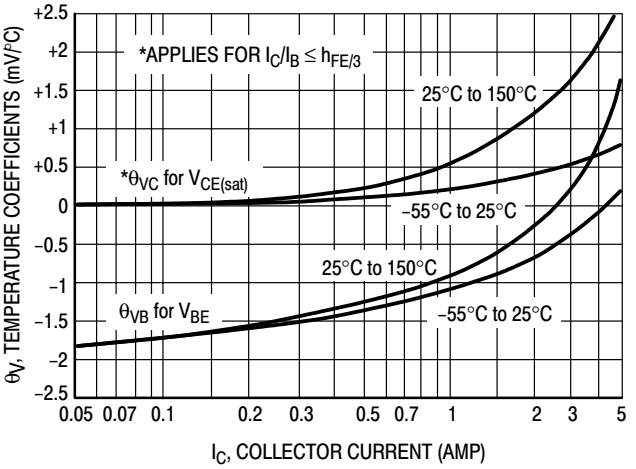


Figure 7. Temperature Coefficients

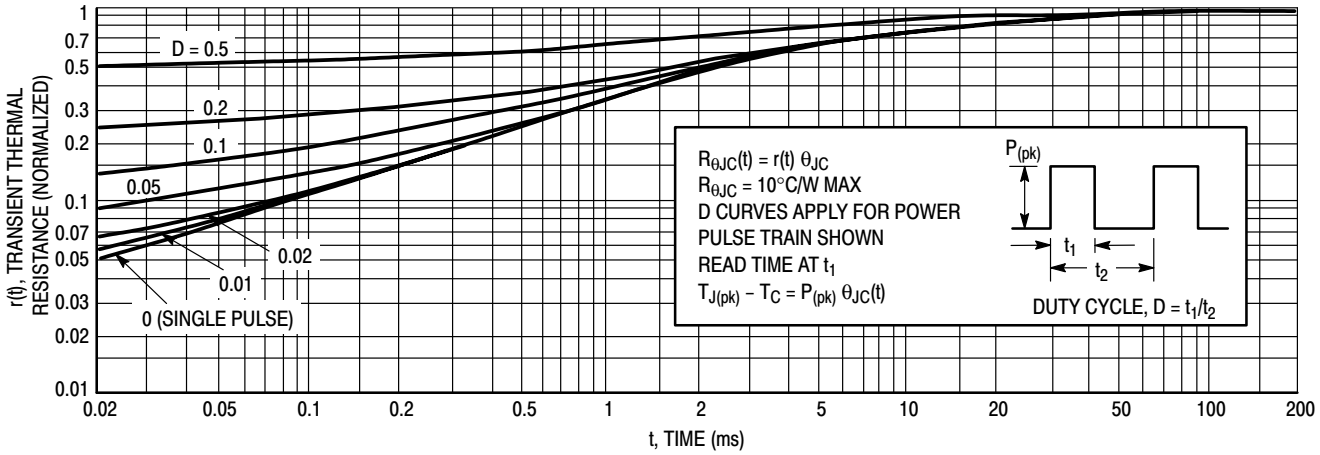


Figure 8. Thermal Response

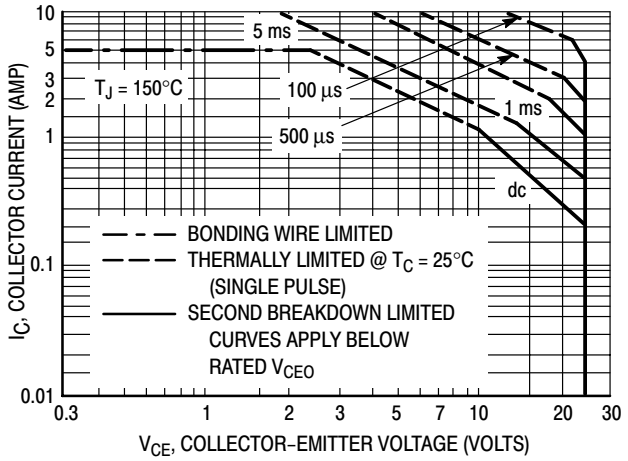


Figure 9. Active Region Safe Operating Area

There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate $I_C - V_{CE}$ limits of the transistor that must be observed for reliable operation; i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

The data of Figure 9 is based on $T_{J(pk)}$ = 150°C; T_C is variable depending on conditions. Second breakdown pulse limits are valid for duty cycles to 10% provided $T_{J(pk)} \leq 150°C$. $T_{J(pk)}$ may be calculated from the data in Figure 8. At high case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by second breakdown.

Case 369 may be ordered by adding a "–1" suffix to the device title (i.e. MJD200–1)

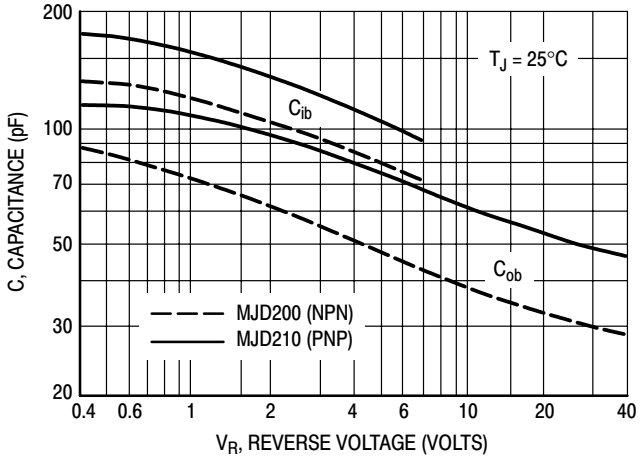
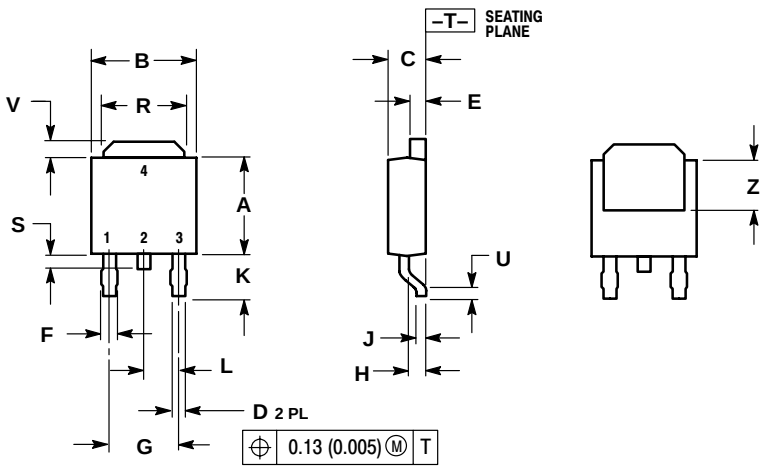


Figure 10. Capacitance

PACKAGE DIMENSIONS

DPAK
CASE 369A−13
ISSUE AA

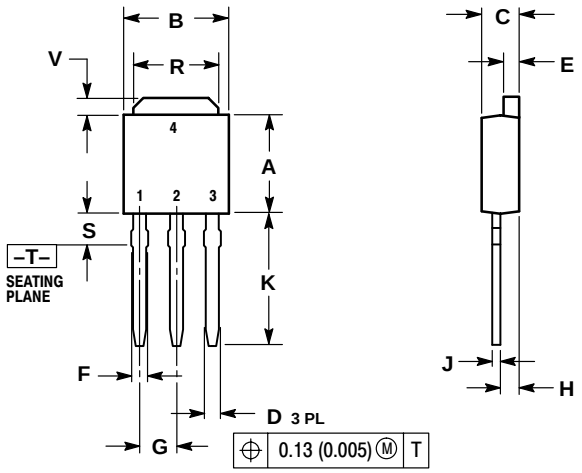


NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
A	0.235	0.250	5.97	6.35
B	0.250	0.265	6.35	6.73
C	0.086	0.094	2.19	2.38
D	0.027	0.035	0.69	0.88
E	0.033	0.040	0.84	1.01
F	0.037	0.047	0.94	1.19
G	0.180 BSC		4.58 BSC	
H	0.034	0.040	0.87	1.01
J	0.018	0.023	0.46	0.58
K	0.102	0.114	2.60	2.89
L	0.090 BSC		2.29 BSC	
R	0.175	0.215	4.45	5.46
S	0.020	0.050	0.51	1.27
U	0.020	---	0.51	---
V	0.030	0.050	0.77	1.27
Z	0.138	---	3.51	---

PACKAGE DIMENSIONS

DPAK
CASE 369–07
ISSUE M



NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
A	0.235	0.250	5.97	6.35
B	0.250	0.265	6.35	6.73
C	0.086	0.094	2.19	2.38
D	0.027	0.035	0.69	0.88
E	0.033	0.040	0.84	1.01
F	0.037	0.047	0.94	1.19
G	0.090 BSC		2.29 BSC	
H	0.034	0.040	0.87	1.01
J	0.018	0.023	0.46	0.58
K	0.350	0.380	8.89	9.65
R	0.175	0.215	4.45	5.46
S	0.050	0.090	1.27	2.28
V	0.030	0.050	0.77	1.27

PUBLICATION ORDERING INFORMATION

Literature Fulfillment:
Literature Distribution Center for ON Semiconductor
P.O. Box 5163, Denver, Colorado 80217 USA
Phone: 303–675–2175 or 800–344–3860 Toll Free USA/Canada
Fax: 303–675–2176 or 800–344–3867 Toll Free USA/Canada
Email: ONlit@hibbertco.com

N. American Technical Support: 800–282–9855 Toll Free USA/Canada

JAPAN: ON Semiconductor, Japan Customer Focus Center
4–32–1 Nishi–Gotanda, Shinagawa–ku, Tokyo, Japan 141–0031
Phone: 81–3–5740–2700
Email: r14525@onsemi.com

ON Semiconductor Website: http://onsemi.com

For additional information, please contact your local
Sales Representative.